
Advanced announcement FO-A Power Module Assembly and Test relocation

To our valued customers,

After the successful relocation of our TO-240 and Y4 product families, I am pleased to announce that we are preparing to consolidate and transfer the next power modules back end operations to our new facility located in Lipa city, Philipines over the coming months.

This Littelfuse facility combines the very best operational excellence and semiconductor expertise to deliver a highly automated, world class facility designed, to meet IATF16949 & VDA6.3 requirements. Our clear focus being to bring high levels of service to our customers and quality products to support future growth of the power semiconductor business.

This time, we will be relocating our **FO-A** power modules product families.
Part numbers for this pacakge type are listed in the appendix.

As a valued customer, we are providing this advanced notification to help facilitate a smooth transition of your business to the new facility.

We are currently running process validation, line qualification and product qualification with a view to issuing the PCN and initial ramp up around end of November 2022 timeframe.

Due to limited 30days timeframe for acceptance we urge your early attention to this matter.

PCN will give the list of the different test and qualification that have been done to release this assembly line and the main changes with current production.

We would highly value your earliest engagement to ensure the smoothest possible transition.

Feel free to contact me should you have any question.

Sincerely,

Pascal Ducluzeau

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September 26th, 2022

Appendix FO-A Package PART NUMBERS

Item	Part number	Package
1	VBO19-16DT1	FO-A
2	VBO25-12NO2	FO-A
3	VBO25-16AO2	FO-A
4	VBO25-16NO2	FO-A

